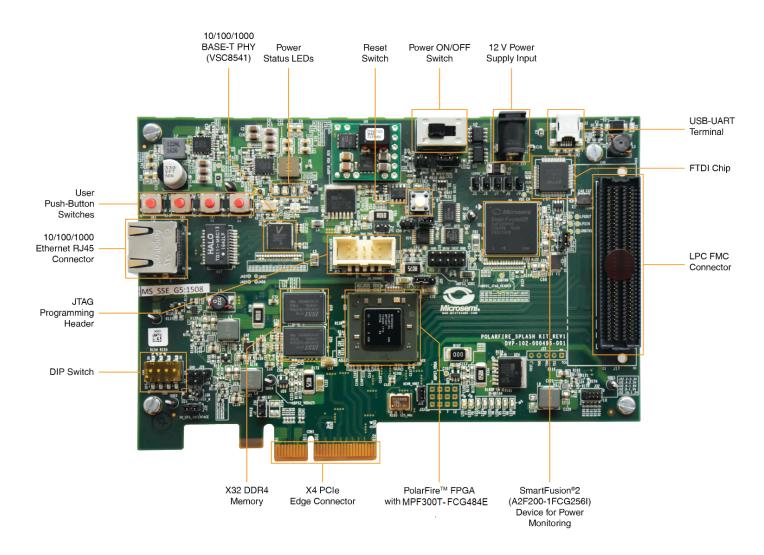


# PolarFire Splash Kit Quickstart Card

#### Kit Contents-MPF300T-FCG484E

Quantity	Description	
1	PolarFire Splash Kit Board with MPF300T-FCG484E device	
1	12 V power pack/AC adapter	
1	USB 2.0 A-male to Mini-B	
1	1 year free Libero Gold Software license	
1	Quickstart card	





#### Overview

Microsemi's PolarFire Splash Kit is a general-purpose hardware platform for evaluating the lowest power, cost-optimized, non-volatile PolarFire FPGAs. This kit has a 300K LE PolarFire FPGA, which integrates reliable non-volatile FPGA fabric, 12.7 Gbps transceivers, 1.6 Gbps I/Os, best-in-class-performance, hardened security IP, and crypto processors. The silicon features power optimization with the lowest static power for 28 nm non-volatile FPGAs, in its low power mode; integrated DDR PHY, PCIe endpoint/ root port, and crypto processor hard IPs.

# **Design Applications**

- Industrial automation
- Wireless access networks and cellular infrastructure
- High-speed I/O
- Imaging and video
- Security
- Power measurement

FMC expansion

#### Hardware Features

- 300K LE PolarFire FPGA in a FCG484 package (MPF300T-FCG484E)
- PCI Express (x4) edge connector
- FMC connector (LPC)
- x32 LPDDR4
- On-board power monitoring

- RJ45 interface for 10/100/1000 Ethernet using SGMII on GPIO
- USB for UART interface and programming
- 1 Gb SPI Flash memory
- JTAG and SPI programming interface



## Programming

Microsemi's PolarFire Evaluation Kit provides FPGA programmability using an on-board embedded FlashPro5 programmer.

The board can also be programmed with standalone FlashPro4/5 hardware (not included with kit).

IAP programming and debug support is also provided on the board.

See Documentation Resources for more information about programming procedures.

# Jumper Settings

Jumper	Pin	Factory Default
J5, J6, J7, J8, J9	2-3	Closed
J4, J11, J32	1-2	Closed

## Running the Demo Design

The PolarFire Splash Board comes with a preprogrammed JESD204B standalone demo design.

## Setting Up the Board

The following steps set up the PolarFire Spash Kit Board to run the JESD204B demo.

- 1. Connect the power supply cable to the **J2** connector on the board.
- 2. Connect the USB cable from the host PC to the **J1** connector (FTDI port) on the board.
- 3. Power on the board using the SW1 slide switch.

The following LEDs glow when the board is completely powered-up and the demo design is running.

- Power supply LEDs: LED1 to LED6
- Demo LEDs: DS1, DS3, DS4, DS5, DS6, and D5



#### Software and Licensing

Libero<sup>®</sup> SoC PolarFire Design Suite offers high productivity with its comprehensive, easy-to-learn, easy-to-adopt development tools for designing with Microsemi's PolarFire FPGAs. The suite integrates industry standard Synopsys Synplify Pro<sup>®</sup> synthesis and Mentor Graphics ModelSim<sup>®</sup> simulation with best-in-class constraints management and debug capabilities.

#### Download the latest Libero SoC release

https://www.microsemi.com/products/fpga-soc/design-resources/design-software/libero-soc-polarfire#downloads

A Gold license is required to program the PolarFire Splash Kit. A Software ID letter enclosed with the kit contains Software ID and instructions on how to generate this license. For more information, see https://www.microsemi.com/products/fpga-soc/design-resources/dev-kits/polarfire/polarfire-splash-kit#licensing

#### **Documentation Resources**

For more information about the PolarFire Splash Kit, including user's guides, tutorials, and design examples, see the documentation at https://www.microsemi.com/products/fpga-soc/fpga/polarfire-fpga#documentation

#### Support

For Technical support log a case at our portal, https://soc.microsemi.com/Portal/Default.aspx.

Microsemi sales offices, including representatives and distributors, are located worldwide. To find your local representative, go to http://www.microsemi.com/salescontacts



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